VS-HFA15TB60-M3

Vishay Semiconductors

HEXFRED[®], Ultrafast Soft Recovery Diode, 15 A



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PRIMARY CHARACTERISTICS							
I _{F(AV)} 15 A							
V _R	600 V						
V _F at I _F	1.2 V						
t _{rr} typ.	23 ns						
T _J max.	150 °C						
Circuit configuration	Single						
Package	TO-220AC 2L						

FEATURES

- Ultrafast and ultrasoft recovery
- Very low I_{RRM} and Q_{rr}
- \bullet Designed and qualified according to JEDEC $^{\textcircled{B}}\text{-}JESD$ 47
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

BENEFITS

- Reduced RFI and EMI
- Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

DESCRIPTION

VS-HFA15TB60... is a state of the art ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600 V and 15 A continuous current, the VS-HFA15TB60... is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I_{BBM}) and does not exhibit any tendency to "snap-off" during the t_b portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED VS-HFA15TB60 ... is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Cathode to anode voltage	V _R		600	V				
Maximum continuous forward current	I _F	T _C = 100 °C	15					
Single pulse forward current	I _{FSM}		150	A				
Maximum repetitive forward current	I _{FRM}		60					
Maximum neuver discinction		T _C = 25 °C	74	W				
Maximum power dissipation	PD	T _C = 100 °C	29	VV V				
Operating junction and storage temperature range	T _J , T _{Stg}		-55 to +150	°C				

RoHS COMPLIANT HALOGEN

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ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS	
Cathode to anode breakdown voltage	V _{BR}	I _R = 100 μA		600	-	-		
		I _F = 15 A	See fig. 1	-	1.3	1.7	V	
Maximum forward voltage	V _{FM}	I _F = 30 A		-	1.5	2.0		
		I _F = 15 A, T _J = 125 °C		-	1.2	1.6		
Maximum reverse	la.	$V_R = V_R$ rated	See fig. 2	-	1.0	10		
leakage current	I _{RM}	T_J = 125 °C, V_R = 0.8 x V_R rated	See fig. 2	-	400	1000	μΑ	
Junction capacitance	CT	V _R = 200 V See fig. 3		-	25	50	pF	
Series inductance	L _S	Measured lead to lead 5 mm from p	ackage body	-	8.0	-	nH	

DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25$ °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS			
	t _{rr}	$I_F = 1.0 \text{ A}, \text{ di}_F/\text{dt} = 200$	A/μs, V _R = 30 V	-	19	-			
Reverse recovery time See fig. 5	t _{rr1}	T _J = 25 °C	I _F = 15 A di _F /dt = 200 A/μs V _R = 200 V	-	42	60	ns		
000 hg. 0	t _{rr2}	T _J = 125 °C		-	74	120			
Peak recovery current	I _{RRM1}	T _J = 25 °C		-	4.0	6.0	A		
See fig. 6	I _{RRM2}	T _J = 125 °C		-	6.5	10			
Reverse recovery charge	Q _{rr1}	T _J = 25 °C		-	84	180			
See fig. 7	Q _{rr2}	T _J = 125 °C		-	241	600			
Peak rate of fall of recovery current during t _b See fig. 8	di _{(rec)M} /dt1	T _J = 25 °C		-	188	-			
	di _{(rec)M} /dt2	T _J = 125 °C		-	160	-	A/µs		

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Lead temperature	T _{lead}	0.063" from case (1.6 mm) for 10 s	-	-	300	°C		
Thermal resistance, junction to case	R _{thJC}		-	-	1.7	K/W		
Thermal resistance, junction to ambient	R _{thJA}	Typical socket mount	-	-	80	- r./ vv		
Woight			-	2.0	-	g		
Weight			-	0.07	-	oz.		
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)		
Marking device		Case style 2L TO-220AC		HFA15TB60				



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Fig. 2 - Typical Reverse Current vs. Reverse Voltage



Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage



Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics



100 = 30 A 15 A 80 5 A 60 t_{rr} (ns) 40 20 = 200 V = 125 °C = 25 °C Тj T₁ 0 1000 100 di_F/dt (A/µs)

Fig. 5 - Typical Reverse Recovery Time vs. di_F/dt



I_{rr} (A)

Fig. 6 - Typical Recovery Current vs. di_F/dt

800 V_R = 200 V T_J = 125 °C T_J = 25 °C 700 600 500 Q_{rr} (nC) I_F = 30 A 400 = 15 A = 5 A 300 200 100 0 100 1000



Fig. 7 - Typical Stored Charge vs. di_F/dt



Fig. 8 - Typical di(rec)M/dt vs. diF/dt



Fig. 9 - Reverse Recovery Waveform and Definitions

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ORDERING INFORMATION TABLE

Device code	VS-	HF	Α	15	тв	60	-M3
	1	2	3	4	5	6	7
	1 - 2 - 3 - 4 -	HEX Elec	nay Serr XFRED [®] ctron irra rent rati	[®] family adiated	·	oduct	
	5 - 6 -	· Pac TB	kage: = 2L TO tage rati	-220AC			
	7		vironmer 8 = halog	-		complia	ant, and

ORDERING INFORMATION (Example)								
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION						
VS-HFA15TB60-M3	50	Antistatic plastic tube						

LINKS TO RELATED DOCUMENTS						
Dimensions www.vishay.com/doc?96156						
Part marking information	www.vishay.com/doc?95391					



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TO-220AC 2L

DIMENSIONS in millimeters and inches



⊕0.015@BA@



SYMBOL	MILLIMETERS		INC	NOTES	
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.50	2.92	0.098	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
С	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.35	0.585	0.604	3
D1	8.38	9.02	0.330	0.355	

SYMBOL	MILLIN	IETERS	INC	INCHES	
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	11.68	13.30	0.460	0.524	6, 7
Е	10.11	10.51	0.398	0.414	3, 6
E1	6.86	8.89	0.270	0.350	6
е	2.41	2.67	0.095	0.105	
e1	4.88	5.28	0.192	0.208	
H1	6.09	6.48	0.240	0.255	6
L	13.52	14.02	0.532	0.552	
L1	3.32	3.82	0.131	0.150	2
ØР	3.54	3.91	0.139	0.154	
Q	2.60	3.00	0.102	0.118	

Conforms to JEDEC[®] outline TO-220AC

Notes

⁽²⁾ Lead dimension and finish uncontrolled in L1

(4) Dimension b1, b3, and c1 apply to base metal only

- (6) Thermal pad contour optional within dimensions E, H1, D2, and E1
- ⁽⁷⁾ Outline conforms to JEDEC[®] TO-220, except D2

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 $^{^{(1)}\,}$ Dimensioning and tolerancing as per ASME Y14.5M-1994 $\,$

⁽³⁾ Dimension D, D1, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

⁽⁵⁾ Controlling dimensions: inches



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